

CAT25C08, CAT25C16

8K/16K SPI Serial CMOS EEPROM

FEATURES

- 10 MHz SPI compatible
- 1.8 to 5.5 volt operation
- SPI modes (0,0 & 1,1)
- 32-byte page write buffer
- Self-timed write cycle
- Hardware and software protection
- Block write protection
- Protect 1/4, 1/2 or all of EEPROM array
 Low power CMOS technology
- 1,000,000 program/erase cycles
- 100 year data retention
- Industrial temperature range
- RoHS-compliant packages

DESCRIPTION

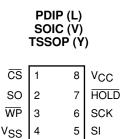
The CAT25C08/16 is a 8K/16K Bit SPI Serial CMOS EEPROM internally organized as 1024x8/2048x8 bits. Catalyst's advanced CMOS Technology substantially reduces device power requirements. The CAT25C08/ 16 features a 32-byte page write buffer. The device operates via the SPI bus serial interface and is enabled though a Chip Select (\overline{CS}). In addition to the Chip Select, the clock input (SCK), data in (SI) and data out (SO) are required to access the device. The HOLD pin may be used to suspend any serial communication without resetting the serial sequence. The CAT25C08/16 is designed with software and hardware write protection features including Block Write protection. The device is available in 8-pin DIP, 8-pin SOIC and 8-pin TSSOP packages.

OGENFR

Compliance

For Ordering Information details, see page 15.

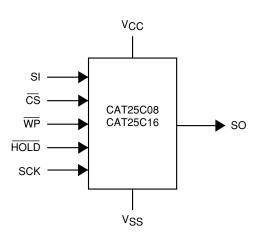
PIN CONFIGURATION



PIN FUNCTIONS

Pin Name	Function			
SO	Serial Data Output			
SCK	Serial Clock			
WP	Write Protect			
Vcc	Power Supply			
V _{SS}	Ground			
CS	Chip Select			
SI	Serial Data Input			
HOLD	Suspends Serial Input			

FUNCTIONAL SYMBOL





ABSOLUTE MAXIMUM RATINGS*

***COMMENT**

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions outside of those listed in the operational sections of this specification is not implied. Exposure to any absolute maximum rating for extended periods may affect device performance and reliability.

RELIABILITY CHARACTERISTICS

Symbol	Parameter	Min.	Тур.	Max.	Units
Nend ⁽³⁾	Endurance	1,000,000			Cycles/Byte
T _{DR} ⁽³⁾	Data Retention	100			Years
VZAP ⁽³⁾	ESD Susceptibility	2000			Volts
I _{LTH} ⁽³⁾⁽⁴⁾	Latch-up	100			mA

D.C. OPERATING CHARACTERISTICS

 V_{CC} = +1.8V to +5.5V, unless otherwise specified.

			Limits			
Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Icc1	Power Supply Current (Operating Write)			5	mA	V _{CC} = 5V @ 5MHz SO=open; CS=Vss
I _{CC2}	Power Supply Current (Operating Read)			3	mA	$V_{CC} = 5.5V$ $F_{CLK} = 5MHz$
I _{SB} ⁽⁶⁾	Power Supply Current (Standby)			1	μA	$\frac{\overline{CS}}{V_{IN}} = V_{CC}$ $V_{IN} = V_{SS} \text{ or } V_{CC}$
ILI	Input Leakage Current			2	μA	
I _{LO}	Output Leakage Current			3	μA	$V_{OUT} = 0V$ to V_{CC} , CS = 0V
VIL ⁽⁵⁾	Input Low Voltage	-1		Vcc x 0.3	V	
V _{IH} ⁽⁵⁾	Input High Voltage	V _{CC} x 0.7		V _{CC} + 0.5	V	
V _{OL1}	Output Low Voltage			0.4	V	2.5V≤V _{CC} <5.5V
VOH1	Output High Voltage	V _{CC} - 0.8			V	I _{OL} = 3.0mA I _{OH} = -1.6mA
V _{OL2}	Output Low Voltage			0.2	V	1.8V≤V _{CC} <2.5V
V _{OH2}	Output High Voltage	V _{CC} -0.2			V	I _{OL} = 150µА I _{OH} = -100µА

Note:

(1) The minimum DC input voltage is -0.5V. During transitions, inputs may undershoot to -1.5V for periods of less than 20 ns. Maximum DC voltage on output pins is V_{CC} +0.5V, which may overshoot to V_{CC} +1.5V for periods of less than 20 ns.

(2) Output shorted for no more than one second. No more than one output shorted at a time.

(3) These parameter are tested initially and after a design or process change that affects the parameter according to appropriate AEC-Q100 and JEDEC test methods.

(4) Latch-up protection is provided for stresses up to 100 mA on address and data pins from -1V to $V_{CC} + 1V$.

(5) V_{ILMIN} and V_{IHMAX} are reference values only and are not tested.

(6) Maximum standby current (I_{SB}) = 10µA for the Automotive and Extended Automotive temperature range.



PIN CAPACITANCE (1)

Applicable over recommended of	provide the second from $T_{4} = 25^{\circ}C_{1} f_{-1} O_{1}$	MHz, VCC= \pm 5.0V (unless otherwise noted).
Applicable over recommended t		

Symbol	Test Conditions	Max.	Units	Conditions
Соит	Output Capacitance (SO)	8	рF	V _{OUT} =0V
CIN	Input Capacitance (CS, SCK, SI, WP, HOLD)	6	рF	V _{IN} =0V

A.C. CHARACTERISTICS

		CAT25Cxx-1.8			CAT2	5Cxx			
		1.8V-5.5V		2.5V-	-5.5V	4.5\	/-5.5V		Test
SYMBOL	PARAMETER	Min.	Max.	Min.	Max.	Min.	Max.	UNITS	Conditions
tsu	Data Setup Time	50		20		20		ns	
tн	Data Hold Time	50		20		20		ns	
twн	SCK High Time	250		75		40		ns	
tw∟	SCK Low Time	250		75		40		ns	
fscк	Clock Frequency	DC	1	DC	5	DC	10	MHz	
t _{LZ}	HOLD to Output Low Z		50		50		20	ns	
t _{RI} ⁽¹⁾	Input Rise Time		2		2		2	μs	
tri ⁽¹⁾	Input Fall Time		2		2		2	μs	
t _{HD}	HOLD Setup Time	100		40		20		ns	
t _{CD}	HOLD Hold Time	100		40		20		ns	
twc ⁽³⁾	Write Cycle Time		10		5		5	ms	$C_L = 50 pF$
t∨	Output Valid from Clock Low		250		75		40	ns	(2)
t _{HO}	Output Hold Time	0		0		0		ns	
tois	Output Disable Time		250		75		75	ns	
t _{HZ}	HOLD to Output High Z		150		50		50	ns	
tcs	CS High Time	500		100		100		ns	
tcss	CS Setup Time	500		100		100		ns	
t _{CSH}	CS Hold Time	500		100		100		ns	
twps	WP Setup Time	150		50		50		ns	
twpн	WP Hold Time	150		50		50		ns	

Power-Up Timing⁽⁴⁾⁽⁵⁾

Symbol	Parameter	Max.	Units
tpur	Power-up to Read Operation	1	ms
tpuw	Power-up to Write Operation	1	ms

NOTE:

AC Test Conditions: (2)

Input Pulse Voltages: 0.3V_{CC} to 0.7V_{CC}

Input rise and fall times: ≤10ns
 Input and output reference voltages: 0.5V_{CC}
 Output load: current source IOL max/IOH max; C_L = 50pF
 (3) t_{WC} is the time from the rising edge of CS after a valid write sequence to the end of the internal write cycle.

(4) This parameter is tested initially and after a design or process change that affects the parameter.

(5) t_{PUR} and t_{PUW} are the delays required from the time V_{CC} is stable until the specified operation can be initiated.

⁽¹⁾ This parameter is tested initially and after a design or process change that affects the parameter.



FUNCTIONAL DESCRIPTION

The CAT25C08/16 supports the SPI bus data transmission protocol. The synchronous Serial Peripheral Interface (SPI) helps the CAT25C08/16 to interface directly with many of today's popular microcontrollers. The CAT25C08/16 contains an 8-bit instruction register. (The instruction set and the operation codes are detailed in the instruction set table)

After the device is selected with \overline{CS} going low, the first byte will be received. The part is accessed via the SI pin, with data being clocked in on the rising edge of SCK. The first byte contains one of the six op-codes that define the operation to be performed.

PIN DESCRIPTION

SI: Serial Input

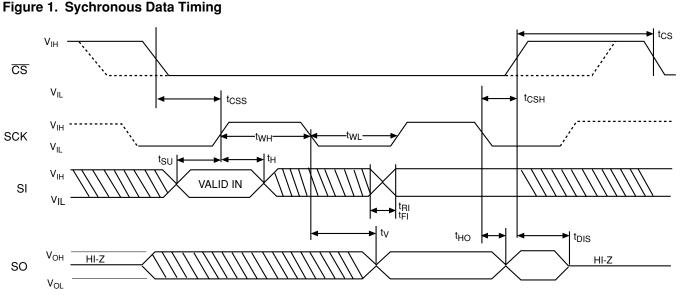
SI is the serial data input pin. This pin is used to input all opcodes, byte addresses, and data to be written to the 25C08/16. Input data is latched on the rising edge of the serial clock for SPI modes (0, 0 & 1, 1).

SO: Serial Output

SO is the serial data output pin. This pin is used to transfer data out of the 25C08/16. During a read cycle, data is shifted out on the falling edge of the serial clock for SPI modes (0,0 & 1,1).

SCK: Serial Clock

SCK is the serial clock pin. This pin is used to synchronize the communication between the microcontroller



Note: Dashed Line= mode (1, 1) -----

INSTRUCTION SET

Instruction Opcode		Operation
WREN	0000 0110	Enable Write Operations
WRDI	0000 0100	Disable Write Operations
RDSR	0000 0101	Read Status Register
WRSR	0000 0001	Write Status Register
READ	0000 0011	Read Data from Memory
WRITE	0000 0010	Write Data to Memory

and the 25C08/16. Opcodes, byte addresses, or data present on the SI pin are latched on the rising edge of the SCK. Data on the SO pin is updated on the falling edge of the SCK for SPI modes (0,0 & 1,1).

CS: Chip Select

 \overline{CS} is the Chip select pin. \overline{CS} low enables the CAT25C08/ 16 and \overline{CS} high disables the CAT25C08/16. \overline{CS} high takes the SO output pin to high impedance and forces the devices into a Standby Mode (unless an internal write operation is underway) The CAT25C08/16 draws ZERO current in the Standby mode. A high to low transition on \overline{CS} is required prior to any sequence being initiated. A low to high transition on \overline{CS} after a valid write sequence is what initiates an internal write cycle.

BYTE ADDRESS

Device	Address Significant Bits	Address Don't Care Bits	# Address Clock Pulse
CAT25C08	A9 - A0	A15 - A10	16
CAT25C16	A10 - A0	A15 - A11	16

STATUS REGISTER

7	7	6	5	4	3	2	1	0
WP	EN	0	1	0	BP1	BP0	WEL	RDY

BLOCK PROTECTION BITS

Status F	Register Bits	Array Address	Protection
BP1	BP0	Protected	
0	0	None	No Protection
0	1	25C08: 0300-03FF 25C16: 0600-07FF	Quarter Array Protection
1	0	25C08: 0200-03FF 25C16: 0400-07FF	Half Array Protection
1	1	25C08: 0000-03FF 25C16: 0000-07FF	Full Array Protection

WRITE PROTECT ENABLE OPERATION

WPEN	WP	WEL	Protected Blocks	Unprotected Blocks	Status Register
0	X	0	Protected	Protected	Protected
0	X	1	Protected	Writable	Writable
1	Low	0	Protected	Protected	Protected
1	Low	1	Protected	Writable	Protected
Х	High	0	Protected	Protected	Protected
Х	High	1	Protected	Writable	Writable



WP: Write Protect

 $\overline{\text{WP}}$ is the Write Protect pin. The Write Protect pin will allow normal read/write operations when held high. When $\overline{\text{WP}}$ is tied low and the WPEN bit in the status register is set to "1", all write operations to the status register are inhibited. $\overline{\text{WP}}$ going low while $\overline{\text{CS}}$ is still low will interrupt a write to the status register. If the internal write cycle has already been initiated, $\overline{\text{WP}}$ going low will have no effect on any write operation to the status register. The $\overline{\text{WP}}$ pin function is blocked when the WPEN bit is set to 0. Figure 10 illustrates the $\overline{\text{WP}}$ timing sequence during a write operation.

HOLD: Hold

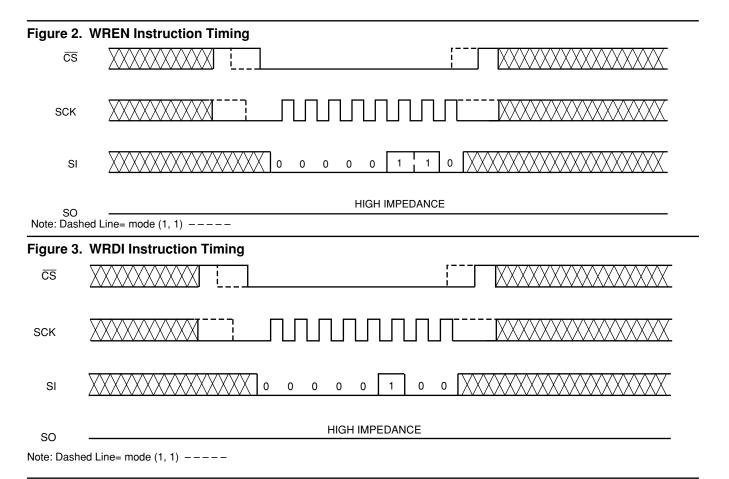
HOLD is the HOLD pin. The HOLD pin is used to pause transmission to the CAT25C08/16 while in the middle of a serial sequence without having to re-transmit entire sequence at a later time. To pause, HOLD must be brought low while SCK is low. The SO pin is in a high impedance state during the time the part is paused, and transitions on the SI pins will be ignored. To resume communication, HOLD is brought high, while SCK is low. HOLD should be held high any time this function is not being used. HOLD may be tied high directly to V_{CC} or tied to V_{CC} through a resistor. Figure 9 illustrates hold timing sequence.

STATUS REGISTER

The Status Register indicates the status of the device. The RDY (Ready) bit indicates whether the CAT25C08/ 16 is busy with a write operation. When set to 1 a write cycle is in progress and when set to 0 the device indicates it is ready. This bit is read only. The WEL (Write Enable) bit indicates the status of the write enable latch. When set to 1, the device is in a Write Enable state and when set to 0 the device is in a Write Disable state. The WEL bit can only be set by the WREN instruction and can be reset by the WRDI instruction.

The BP0 and BP1 (Block Protect) bits indicate which blocks are currently protected. These bits are set by the user issuing the WRSR instruction. The user is allowed to protect quarter of the memory, half of the memory or the entire memory by setting these bits. Once protected the user may only read from the protected portion of the array. These bits are non-volatile.

The WPEN (Write Protect Enable) is an enable bit for the \overline{WP} pin. The \overline{WP} pin and WPEN bit in the status register control the programmable hardware write protect feature. Hardware write protection is enabled when \overline{WP} is low and WPEN bit is set to high. The user cannot write to the status register, (including the block protect



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bits and the WPEN bit) and the block protected sections in the memory array when the chip is hardware write protected. Only the sections of the memory array that are not block protected can be written. Hardware write protection is disabled when either \overline{WP} pin is high or the WPEN bit is zero.

DEVICE OPERATION

Write Enable and Disable

The CAT25C08/16 contains a write enable latch. This latch must be set before any write operation. The device powers up in a write disable state when V_{cc} is applied. WREN instruction will enable writes (set the latch) to the device. WRDI instruction will disable writes(reset the latch) to the device. Disabling writes will protect the device against inadvertent writes.

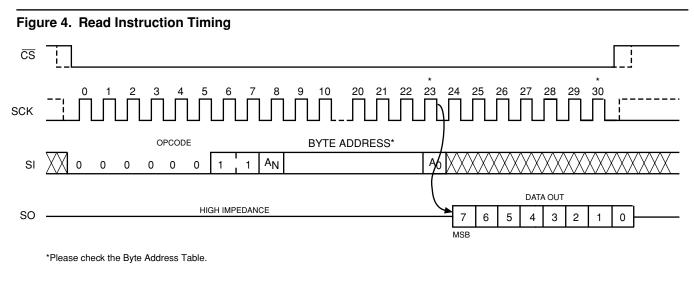
READ Sequence

The part is selected by pulling \overline{CS} low. The 8-bit read instruction is transmitted to the CAT25C08/16, followed by the 16-bit address for 25C08/16. (only 10-bit addresses are used for 25C08, 11-bit addresses are used for 25C16. The rest of the bits are don't care bits).

After the correct read instruction and address are sent, the data stored in the memory at the selected address is shifted out on the SO pin. The data stored in the memory at the next address can be read sequentially by continuing to provide clock pulses. The internal address pointer is automatically incremented to the next higher address after each byte of data is shifted out. When the highest address is reached, the address counter rolls over to 0000h allowing the read cycle to be continued indefinitely. The read operation is terminated by pulling the \overline{CS} high. To read the status register, RDSR instruction should be sent. The contents of the status register are shifted out on the SO line. The status register may be read at any time even during a write cycle. Read sequece is illustrated in Figure 4. Reading status register is illustrated in Figure 5.

WRITE Sequence

The CAT25C08/16 powers up in a Write Disable state. Prior to any write instructions, the WREN instruction must be sent to CAT25C08/16. The device goes into Write enable state by pulling the \overline{CS} low and then clocking the WREN instruction into CAT25C08/16. The \overline{CS} must be brought high after the WREN instruction to enable writes to the device. If the write operation is initiated immediately after the WREN instruction without \overline{CS} being brought high, the data will not be written to the array because the write enable latch will not have been properly set. Also, for a successful write operation the address of the memory location(s) to be programmed must be outside the protected address field location selected by the block protection level.



Note: Dashed Line= mode (1, 1) - - - -



Byte Write

Once the device is in a Write Enable state, the user may proceed with a write sequence by setting the \overline{CS} low, issuing a write instruction via the SI line, followed by the 16-bit address for 25C08/16. (only 10-bit addresses are used for 25C08, 11-bit addresses are used for 25C16. The rest of the bits are don't care bits). Programming will start after the \overline{CS} is brought high. Figure 6 illustrates byte write sequence. During an internal write cycle, all commands will be ignored except the RDSR (Read Status Register) instruction.

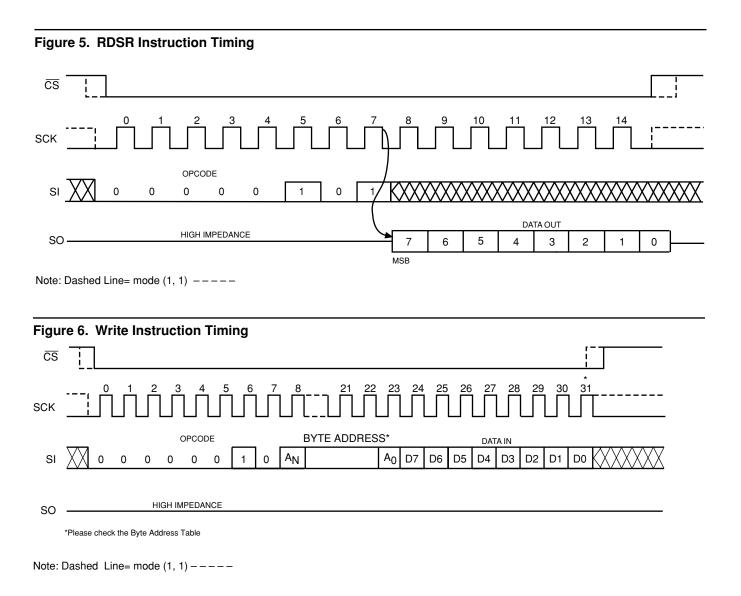
The Status Register can be read to determine if the write cycle is still in progress. If Bit 0 of the Status Register is set at 1, write cycle is in progress. If Bit 0 is set at 0, the device is ready for the next instruction

Page Write

The CAT25C08/16 features page write capability. After the initial byte, the host may continue to write up to 32

bytes. After each byte of data received, lower order address bits are internally incremented by one; the high order bits of address will remain constant. The only restriction is that the 32 bytes must reside on the same page. If the address counter reaches the end of the page and clock continues, the counter will "roll over" to the first address of the page and overwrite any data that may have been written. The CAT25C08/16 is automatically returned to the write disable state at the completion of the write cycle. Figure 8 illustrates the page write sequence.

To write to the status register, the WRSR instruction should be sent. Only Bit 2, Bit 3 and Bit 7 of the status register can be written using the WRSR instruction. Figure 7 illustrates the sequence of writing to status register.

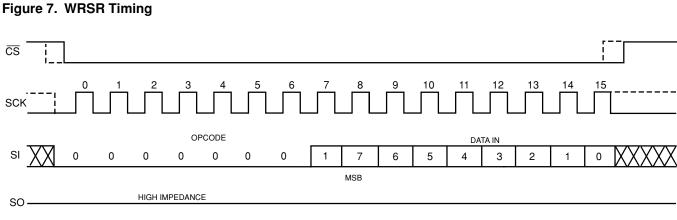


DESIGN CONSIDERATIONS

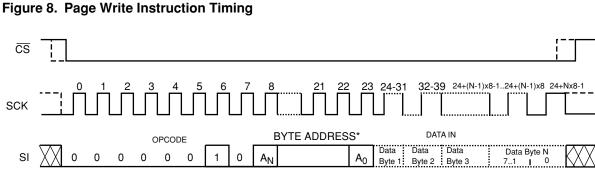
The CAT25C08/16 powers up in a write disable state and in a low power standby mode. A WREN instruction must be issued to perform any writes to the device after power up. Also, on power up CS should be brought low to enter a ready state and receive an instruction. After a successful byte/page write or status register write, the CAT25C08/16 goes into a write disable mode. CS must be set high after the proper number of clock cycles to start an internal write cycle. Access to the array during an internal write cycle is ignored and programming is continued. On power up, SO is in a high impedance. If an invalid op code is received, no data will be shifted

into the CAT25C08/16, and the serial output pin (SO) will remain in a high impedance state until the falling edge of \overline{CS} is detected again.

When powering down, the supply should be taken down to 0V, so that the CAT25C08/16 will be reset when power is ramped back up. If this is not possible, then, following a brown-out episode, the CAT25C08/16 can be reset by refreshing the contents of the Status Register (See Application Note AN10).



Note: Dashed Line= mode (1, 1) -----



SO

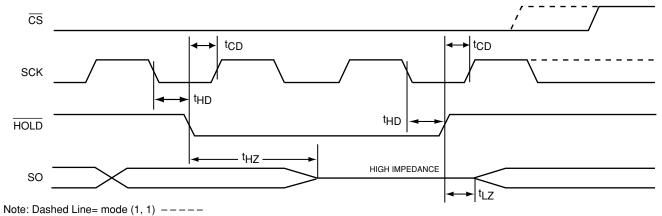
HIGH IMPEDANCE

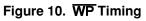
*Please check the Byte Address Table

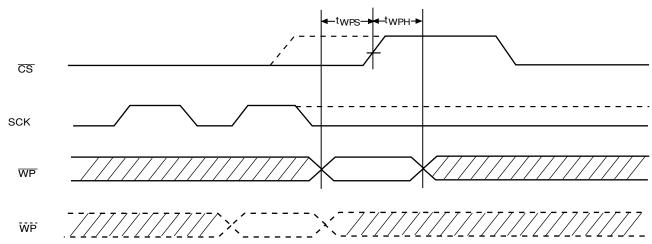
Note: Dashed Line= mode (1, 1) - - - - -



Figure 9. HOLD Timing



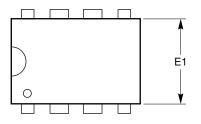


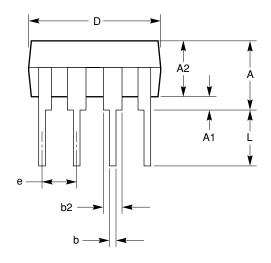


Note: Dashed Line= mode (1, 1) - - - -

PACKAGE INFORMATION

8-LEAD 300 MIL WIDE PLASTIC DIP (L)





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[] 	— eB –	>

SYMBOL	MIN	NOM	MAX
A			4.57
A1	0.38		
A2	3.05		3.81
b	0.36	0.46	0.56
b2	1.14		1.77
D	9.02		10.16
E	7.62	7.87	8.25
E1	6.09	6.35	7.11
е	2.54 BSC		
eB	7.87		9.65
L	0.115	0.130	0.150

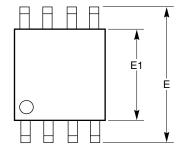
24C16_8-LEAD_DIP_(300P).eps

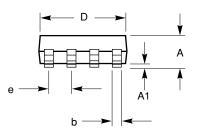
Notes:

- 1. All dimensions are in millimeters.
- 2.
- Complies with JEDEC Standard MS001. Dimensioning and tolerancing per ANSI Y14.5M-1982 3.

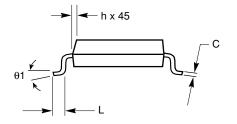


8-LEAD 150 MIL WIDE SOIC (V)





SYMBOL	MIN	NOM	MAX
A1	0.10		0.25
A	1.35		1.75
b	0.33		0.51
С	0.19		0.25
D	4.80		5.00
E	5.80		6.20
E1	3.80		4.00
е		1.27 BSC	
h	0.25		0.50
L	0.40		1.27
θ1	0 °		8°

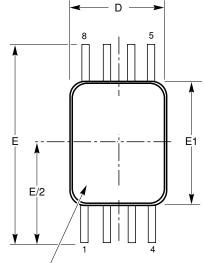


24C16_8-LEAD_SOIC.eps

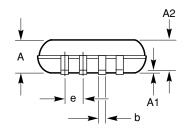
Notes:

All dimensions are in millimeters.
 Complies with JEDEC specification MS-012.

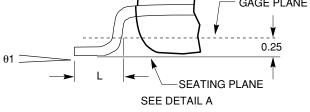
8-LEAD TSSOP (Y)



PIN #1 IDENT.



SEE DETAIL A
¢ ¢ ¢
GAGE PLANE



SYMBOL	MIN	NOM	МАХ
A			1.20
A1	0.05		0.15
A2	0.80	0.90	1.05
b	0.19		0.30
с	0.09		0.20
D	2.90	3.00	3.10
E	6.30	6.4	6.50
E1	4.30	4.40	4.50
е	0.65 BSC		
L	0.50	0.60	0.75
θ1	0.00		8.00

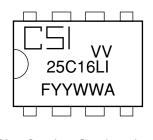
Notes:

All dimensions are in millimeters.
 Complies with JEDEC Standard MO-153



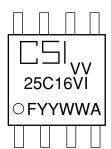
PACKAGE MARKING

8-Lead PDIP



CSI = Catalyst Semiconductor, Inc. 25C16L = Device Code 25C08L 25C16L I = Temperature Range F = Lead Finish 4 = NiPdAu 3 = Matte-Tin YY = Production Year WW = Production Year WW = Product Revision VV = Voltage Range 1.8V - 5.5V = 18 2.5V - 5.5V = Blank

8-Lead SOIC

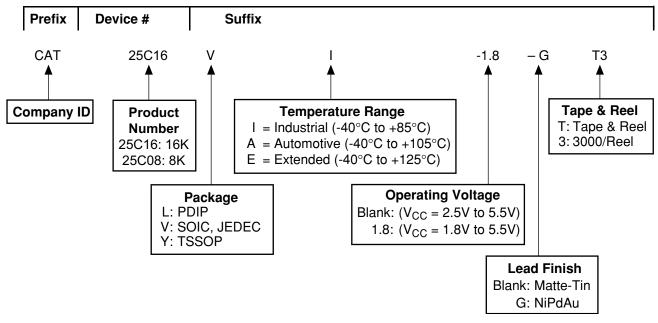


CSI = Catalyst Semiconductor, Inc. 25C16V = Device Code 25C08V 25C16V I = Temperature Range F = Lead Finish 4 = NiPdAu 3 = Matte-Tin YY = Production Year WW = Production Week A = Product Revision VV = Voltage Range 1.8V - 5.5V = 18 2.5V - 5.5V = Blank

8-Lead TSSOP

 $^{\bigcirc}$ YMBF 25Y16 Y = Production Year M = Production Month A = Die Revision25Y16 = Device Code 25Y08 25Y16 I = Industrial Temperature Range F = Voltage Range + Lead Finish Matte-Tin 1.8V - 5.5V = S2.5V - 5.5V = T NiPdAu 1.8V - 5.5V = A 2.5V - 5.5V = G

EXAMPLE OF ORDERING INFORMATION



Notes:

- (1) All packages are RoHS-compliant (Lead-free, Halogen-free).
- (2) The standard lead finish is NiPdAu.
- (3) The device used in the above example is a CAT25C16VI-1.8GT3 (SOIC, Industrial Temperature, 1.8V to 5.5V Operating Voltage, NiPdAu, Tape & Reel).
- (4) For additional package and temperature options, please contact your nearest Catalyst Semiconductor Sales office.

REVISION HISTORY

Date	Rev.	Reason	
03/21/2006	А	Initial Issue	
05/25/2006	В	Update Features Update Absolute Maximum Ratings Update A.C. Characteristics Update Status Register Update Figure 8 Update Package Information Remove Tape & Reel Update Package Marking Update Example of Ordering Information	
10/13/06	С	Update Features Update Pin Configuration Update Pin Functions Update D.C. Operating Characteristics Update Package Information Update Example of Ordering Information	

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